

CMOS Quad 3-State R/S Latches

High-Voltage Types (20-Volt Rating)

Quad NOR R/S Latch – CD4043B

Quad NAND R/S Latch – CD4044B

■ CD4043B types are quad cross-coupled 3-state CMOS NOR latches and the CD4044B types are quad cross-coupled 3-state CMOS NAND latches. Each latch has a separate Q output and individual SET and RESET inputs. The Q outputs are controlled by a common ENABLE input. A logic "1" or high on the ENABLE input connects the latch states to the Q outputs. A logic "0" or low on the ENABLE input disconnects the latch states from the Q outputs, resulting in an open circuit condition on the Q outputs. The open circuit feature allows common busing of the outputs.

The CD4043B and CD4044B types are supplied in 16-lead hermetic dual-in-line ceramic packages (F3A suffix), 16-lead dual-in-line plastic packages (E suffix), 16-lead small-outline packages (D, DR, DT, DW, DWR, and NSR suffixes), and 16-lead thin shrink small-outline packages (PW and PWR suffixes).

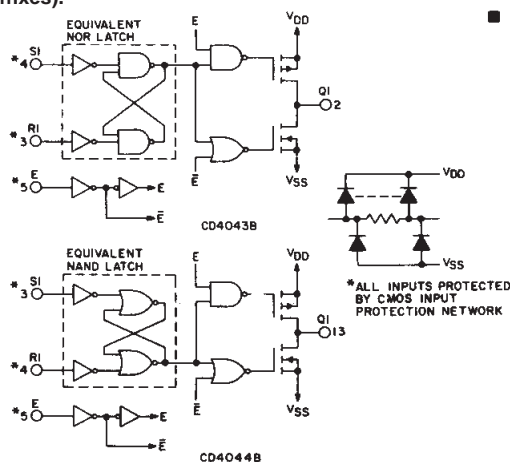


Fig. 1 - Logic diagrams.

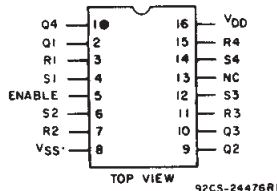
Features:

- 3-state outputs with common output ENABLE
- Separate SET and RESET inputs for each latch
- NOR and NAND configurations
- 5-V, 10-V, and 15-V parametric ratings
- Standardized symmetrical output characteristics
- 100% tested for quiescent current at 20 V
- Maximum input current of 1 μ A at 18 V over full package temperature range; 100 nA at 18 V and 25°C
- Noise margin (over full package temperature range):
 - 1 V at $V_{DD} = 5$ V
 - 2 V at $V_{DD} = 10$ V
 - 2.5 V at $V_{DD} = 15$ V

- Meets all requirements of JEDEC Tentative Standard No. 18B, "Standard Specifications for Description of 'B' Series CMOS Devices"

Applications:

- Holding register in multi-register system
- Four bits of independent storage with output ENABLE
- Strobed register
- General digital logic
- CD4043B for positive logic systems
- CD4044B for negative logic systems



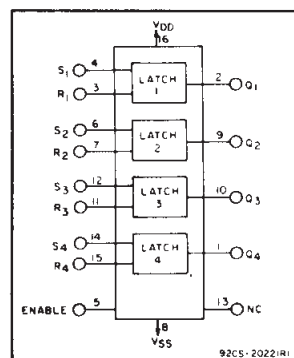
CD4043B

TERMINAL ASSIGNMENTS

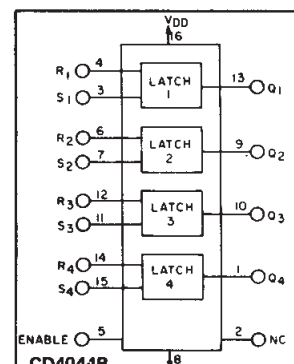
S	R	E	Q
X	X	0	OC*
0	0	1	NC*
1	0	1	1
0	1	1	0
1	1	1	Δ

* OPEN CIRCUIT
+ NO CHANGE
 Δ DOMINATED BY S=1 INPUT

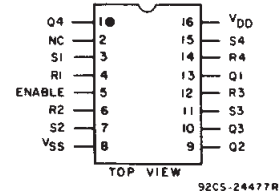
CD4043B



CD4043B
FUNCTIONAL DIAGRAM



CD4044B
FUNCTIONAL DIAGRAM



CD4044B

TERMINAL ASSIGNMENTS

S	R	E	Q
X	X	0	OC*
1	1	1	NC*
0	1	1	1
1	0	1	0
0	0	1	Δ

* OPEN CIRCUIT
+ NO CHANGE
 Δ DOMINATED BY R=0 INPUT

CD4044B

TRUTH TABLES

Recommended Operating Conditions $T_A = 25^\circ\text{C}$
For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges.

Characteristic	V_{DD} (V)	Min.	Max.	Units
Supply-Voltage Range (T_A = Full Package Temperature Range)	—	3	18	V
SET or RESET Pulse Width, t_W	5	160	—	ns
	10	80	—	
	15	40	—	

CD4043B, CD4044B Types

STATIC ELECTRICAL CHARACTERISTICS

CHARACTER- ISTIC	CONDITIONS			LIMITS AT INDICATED TEMPERATURES (°C)							UNITS
	V _O (V)	V _{IN} (V)	V _{DD} (V)					+25			
				-55	-40	+85	+125	Min.	Typ.	Max.	
Quiescent Device Current, I _{DD} Max.	—	0,5	5	1	1	30	30	—	0.02	1	μA
	—	0,10	10	2	2	60	60	—	0.02	2	
	—	0,15	15	4	4	120	120	—	0.02	4	
	—	0,20	20	20	20	600	600	—	0.04	20	
Output Low (Sink) Current I _{OL} Min.	0.4	0,5	5	0.64	0.61	0.42	0.36	0.51	1	—	mA
	0.5	0,10	10	1.6	1.5	1.1	0.9	1.3	2.6	—	
	1.5	0,15	15	4.2	4	2.8	2.4	3.4	6.8	—	
Output High (Source) Current, I _{OH} Min.	4.6	0,5	5	-0.64	-0.61	-0.42	-0.36	-0.51	-1	—	mA
	2.5	0,5	5	-2	-1.8	-1.3	-1.15	-1.6	-3.2	—	
	9.5	0,10	10	-1.6	-1.5	-1.1	-0.9	-1.3	-2.6	—	
	13.5	0,15	15	-4.2	-4	-2.8	-2.4	-3.4	-6.8	—	
Output Voltage: Low-Level, V _{OL} Max.	—	0,5	5	0.05				—	0	0.05	V
	—	0,10	10	0.05				—	0	0.05	
	—	0,15	15	0.05				—	0	0.05	
Output Voltage: High-Level, V _{OH} Min.	—	0,5	5	4.95				4.95	5	—	V
	—	0,10	10	9.95				9.95	10	—	
	—	0,15	15	14.95				14.95	15	—	
Input Low Voltage, V _{IL} Max.	0.5, 4.5	—	5	1.5				—	—	1.5	V
	1, 9	—	10	3				—	—	3	
	1.5, 13.5	—	15	4				—	—	4	
Input High Voltage, V _{IH} Min.	0.5, 4.5	—	5	3.5				3.5	—	—	V
	1, 9	—	10	7				7	—	—	
	1.5, 3.5	—	15	11				11	—	—	
Input Current I _{IN} Max.	—	0,18	18	±0.1	±0.1	±1	±1	—	±10 ⁻⁵	±0.1	μA
3-State Output Leakage Current I _{OUT} Max.	0,18	0,18	18	±0.4	±0.4	±12	±12	—	±10 ⁻⁴	±0.4	μA

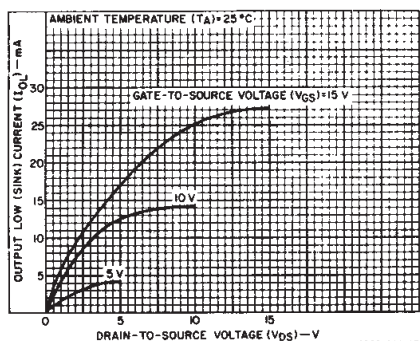


Fig. 2 — Typical output low (sink) current characteristics.

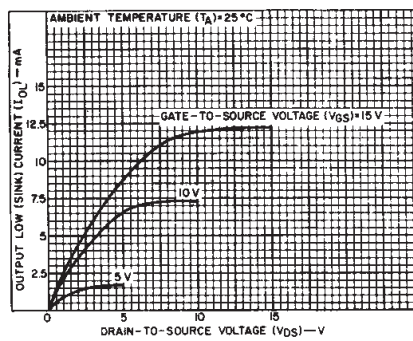


Fig. 3 — Minimum output low (sink) current characteristics.

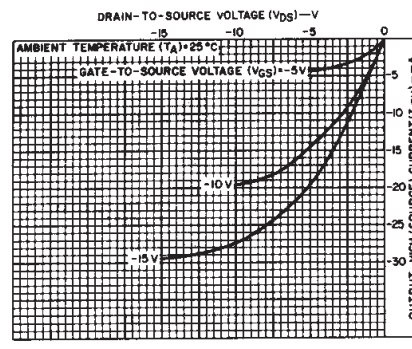


Fig. 4 — Typical output high (source) current characteristics.

CD4043B, CD4044B Types

DYNAMIC ELECTRICAL CHARACTERISTICS at $T_A = 25^\circ\text{C}$; Input $t_r, t_f = 20\text{ ns}$,
 $C_L = 50\text{ pF}$, $R_L = 200\text{ K}\Omega$

CHARACTERISTIC	V_{DD} (V)	LIMITS ALL TYPES		UNITS
		TYP.	MAX.	
Propagation Delay Time: t_{PHL} , t_{PLH} SET or RESET to Q	5 10 15	150 70 50	300 140 100	ns
3-State Propagation Delay Time: ENABLE to Q t_{PHZ} , t_{PZH}	5 10 15	115 55 40	230 110 80	ns
t_{PLZ} , t_{PZL}	5 10 15	90 50 35	180 100 70	ns
Transition Time: t_{THL} , t_{TLH}	5 10 15	100 50 40	200 100 80	ns
Minimum SET or RESET Pulse Width, t_W	5 10 15	80 40 20	160 80 40	ns
Input Capacitance, (Any Input) C_{IN}	—	5	7.5	pF

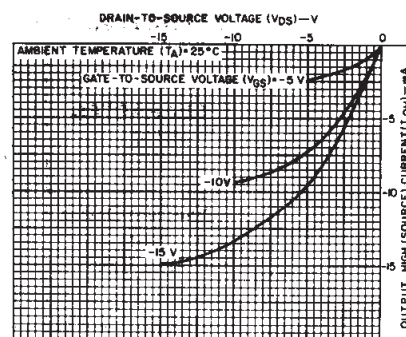


Fig. 5 — Minimum output high (source) current characteristics.

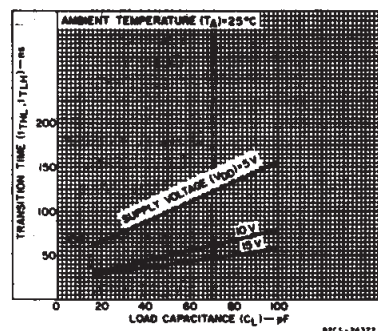


Fig. 6 — Typical transition time vs. load capacitance.

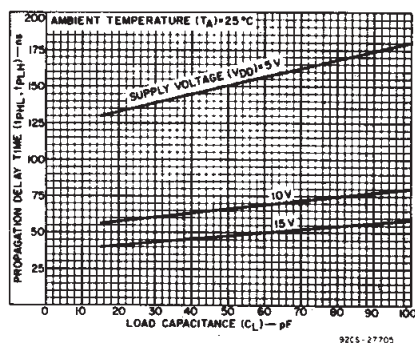


Fig. 7 — Typical propagation delay time vs. load capacitance—SET, RESET to Q, \bar{Q} .

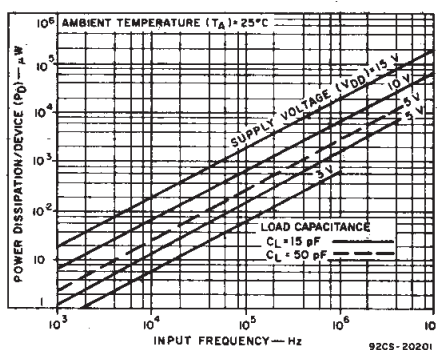


Fig. 8 — Typical power dissipation vs. frequency.

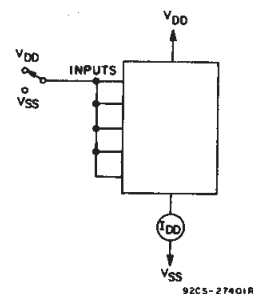


Fig. 9 — Quiescent device current.

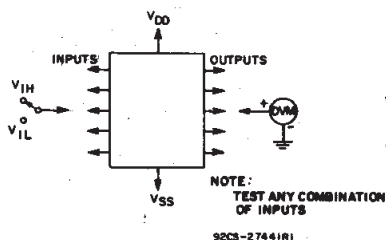


Fig. 10 — Input voltage.

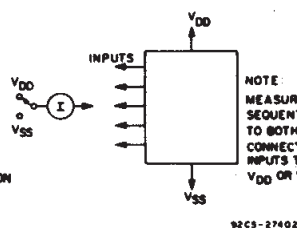


Fig. 11 — Input current.

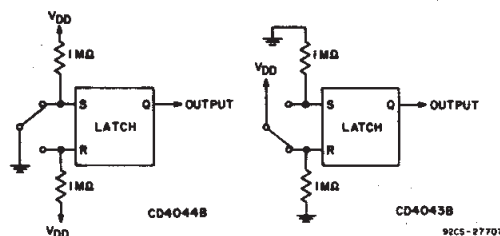


Fig. 12 — Switch bounce eliminator.